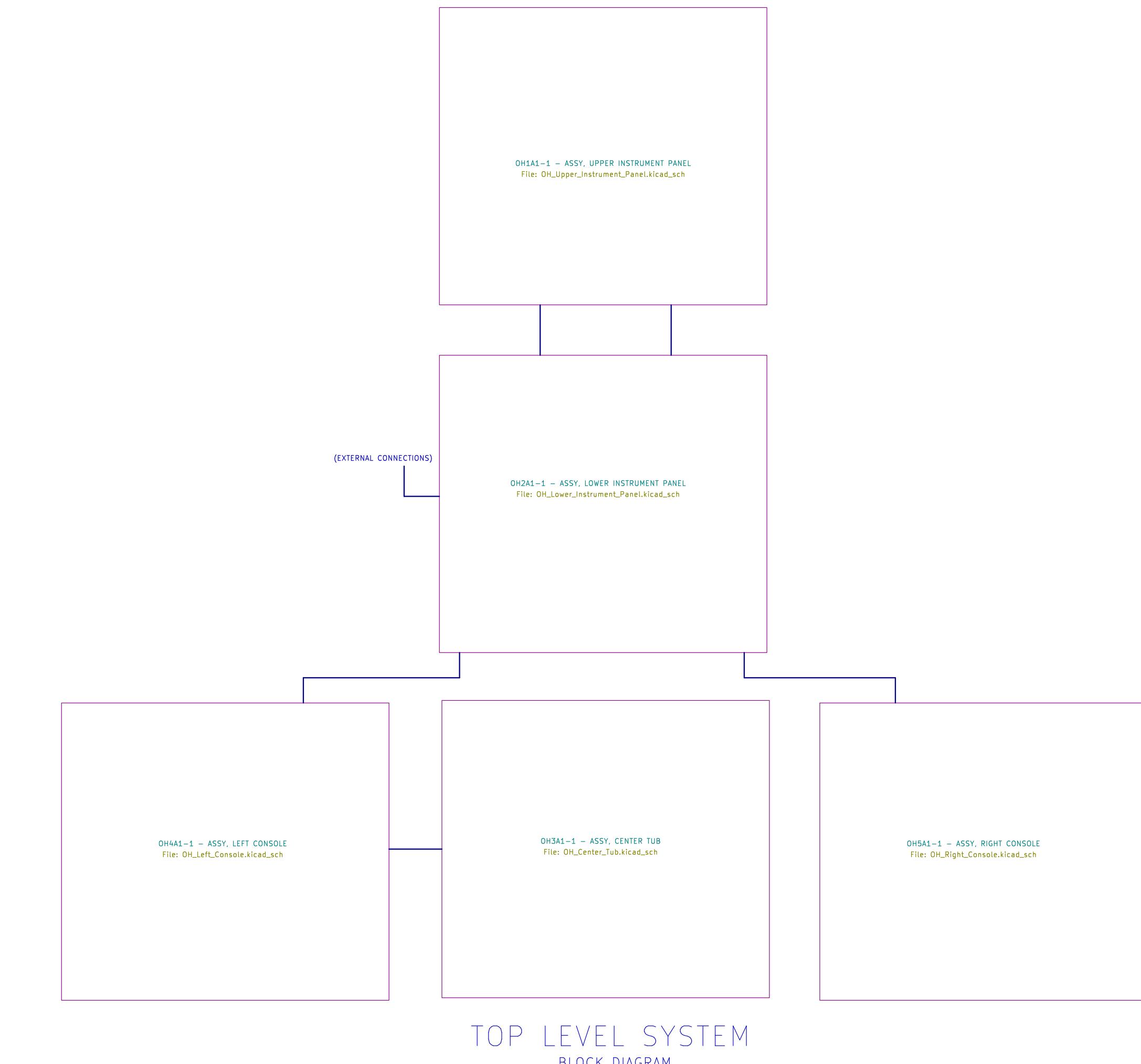


NOTES: (UNLESS OTHERWISE SPECIFIED)

- SEE OH-PL-INTERCONNECT FOR SEPARATE INTERCONNECT PARTS LIST.
- SEE OH-SPEC-002 FOR ABSIS CABLE SPECIFICATIONS.
- ALL CONDUCTORS SHALL BE WHITE STRANDED/BRAIDED INSULATED WIRES OF 26AWG FOR ALL POWER CONNECTIONS, AND 28AWG FOR ALL SIGNAL/DATA CONNECTIONS.
- CABLE COLOR SCHEMES MAY BE ALTERED TO IDENTIFY CONDUCTOR FUNCTION. IF A DIFFERENT CABLE COLOR SCHEME IS USED, DOCUMENT COLOR SCHEME AS APPROPRIATE.
- TERMINATE ALL UNUSED CONDUCTORS BY FOLDING BACK CONDUCTORS AND HEAT SHRINKING CONDUCTOR ALONG CABLE.
- INSTALL USB 3.0 PCIE CARD INTO HOST PC. USE MOTHERBOARD-BASED USB PORTS AT OWN RISK.



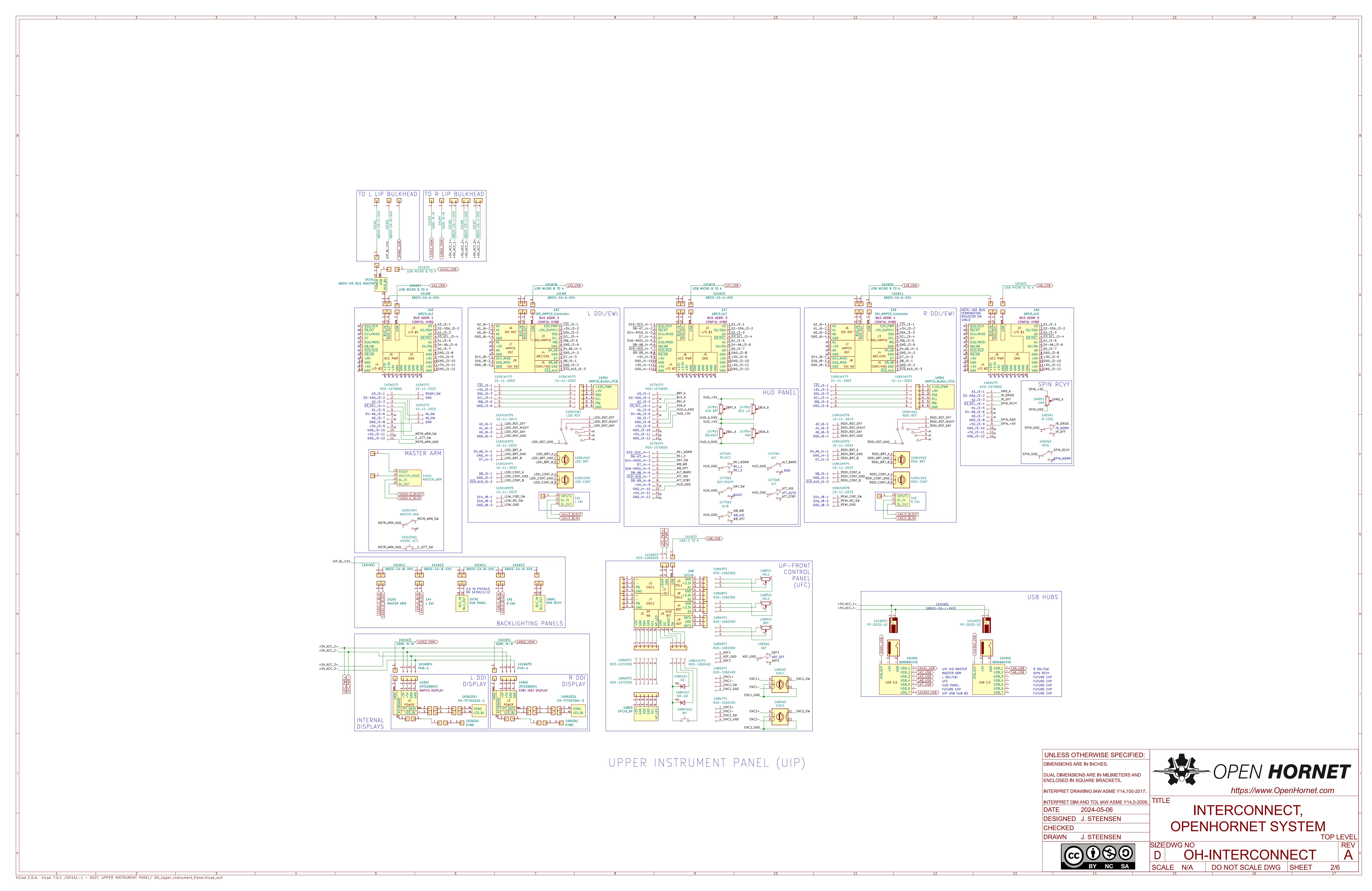
UNLESS OTHERWISE SPECIFIED: DIMENSIONS ARE IN INCHES. DUAL DIMENSIONS ARE IN MILLIMETERS AND ENCLOSED IN SQUARE BRACKETS.	
INTERPRET DRAWING IAW ASME Y14.100-2017.	
INTERPRET DIM AND TOL IAW ASME Y14.5-2009.	
DATE 2024-05-06	
DESIGNED J. STEENSEN	
CHECKED	
DRAWN J. STEENSEN	
SIZE DWG NO D OH-INTERCONNECT REV A	
SCALE N/A DO NOT SCALE DWG SHEET 1/6	

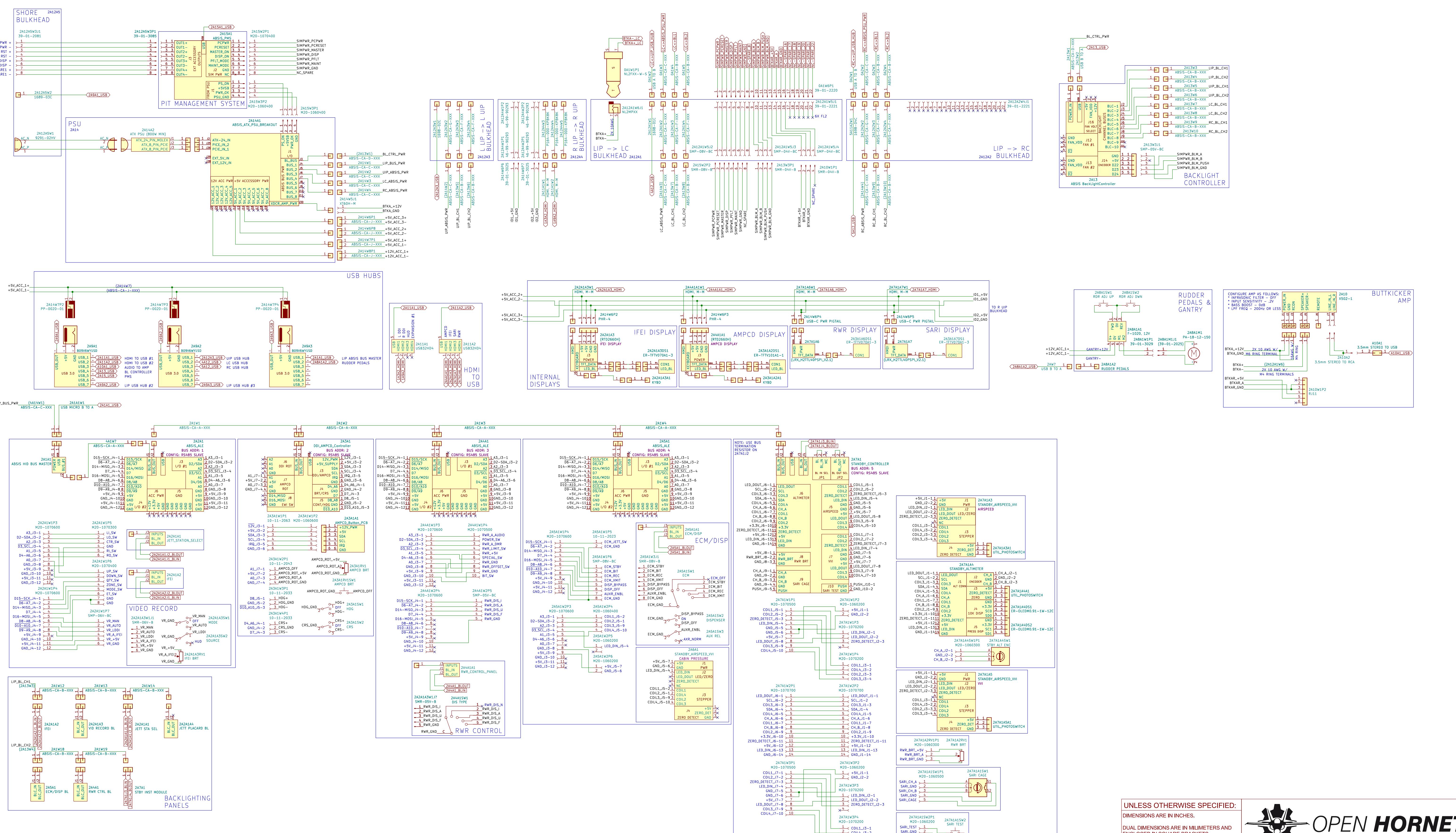


<https://www.OpenHornet.com>

INTERCONNECT, OPENHORNET SYSTEM

TOP LEVEL





LOWER INSTRUMENT PANEL (LIP)

SS OTHERWISE SPECIFIED:

**DIMENSIONS ARE IN MILLIMETERS AND
DEPTH IN SQUARE BRACKETS.**

ED IN SQUARE BRACKETS.		https://www.OpenHornet.com
RET DRAWING IAW ASME Y14.100-2017.		TITLE INTERCONNECT, OPENHORNET SYSTEM
RET DIM AND TOL IAW ASME Y14.5-2009.		
2024-05-06		
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KED		
V/N	J. STEENSEN	TOP LE



